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**ON Semiconductor®** 

### FDS6680A

#### Single N-Channel, Logic Level, PowerTrench<sup>®</sup> MOSFET

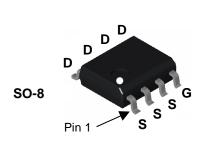
#### **General Description**

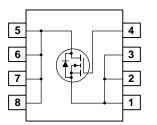
This N-Channel Logic Level MOSFET is produced using ON Semiconductor's advanced Power Trench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

#### Features

- 12.5 A, 30 V  $R_{DS(ON)} = 9.5 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$  $R_{DS(ON)} = 13 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$
- Ultra-low gate charge
- + High performance trench technology for extremely low  $R_{\text{DS}(\text{ON})}$
- High power and current handling capability





#### Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		30	V
V <sub>GSS</sub>	Gate-Source Voltage		±20	
ID	Drain Current – Continuous	(Note 1a)	12.5	A
	– Pulsed		50	
P <sub>D</sub>	Power Dissipation for Single Operation	(Note 1a)	2.5	W
		(Note 1b)	1.2	
		(Note 1c)	1.0	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperat	ure Range	-55 to +150	°C

#### **Thermal Characteristics**

R <sub>eJC</sub> Thermal Resistance, Junction-to-Case (Note 1) 25	

#### Package Marking and Ordering Information

FDS6680A FDS6680A 13" 12mm 2500 units	Device Marking	Device	Reel Size	Tape width	Quantity
	FDS6680A	FDS6680A		12mm	2500 units

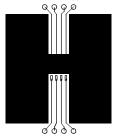
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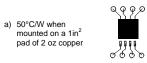
Publication Order Number: FDS6680A/D

Downloaded from Arrow.com.

Symbol	Parameter	Test Conditions	Min	Tun	Max	Units
Symbol		Test Conditions	IVIIN	Тур	wax	Units
BV <sub>DSS</sub>	acteristics Drain–Source Breakdown Voltage	V = 0.V = 1 = 250 ··· 0	30		1	V
	Breakdown Voltage Temperature	$V_{GS} = 0 V$ , $I_D = 250 \mu A$	30			v
$\Delta T_{J}$	Coefficient	$I_D = 250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$		25		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 24 \text{ V}, \qquad V_{\text{GS}} = 0 \text{ V}$			1	μA
		$V_{DS} = 24 V$ , $V_{GS} = 0 V$ , $T_J = 55^{\circ}C$			10	μA
I <sub>GSS</sub>	Gate–Body Leakage	$V_{GS}=\pm 20~V, ~~V_{DS}=0~V$			±100	nA
On Chara	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, \qquad I_{\text{D}} = 250 \ \mu\text{A}$	1	2	3	V
$rac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$		-4.9		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source	$V_{GS} = 10 \text{ V}, \qquad I_D = 12.5 \text{ A}$		7.8	9.5	mΩ
	On-Resistance	$V_{GS} = 4.5 \text{ V},  I_D = 10.5 \text{ A}$		9.9	13	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 12.5 \text{ A}, \text{ T}_{J} = 125^{\circ}\text{C}$	05	11.0	15	•
I <sub>D(on)</sub>	On–State Drain Current	$V_{GS} = 10 \text{ V},  V_{DS} = 5 \text{ V}$	25	0.4		A
g <sub>FS</sub>	Forward Transconductance	$V_{DS} = 15 \text{ V}, \qquad I_{D} = 12.5 \text{ A}$		64		S
	Characteristics			4000	r	
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 15 V$ , $V_{GS} = 0 V$ , f = 1.0 MHz		1620		pF
Coss	Output Capacitance			380		pF
C <sub>rss</sub>	Reverse Transfer Capacitance	\/ 15 m\/ 6 10 MU		160 1.3		pF
	Gate Resistance	$V_{GS}$ = 15 mV, f = 1.0 MHz		1.3		Ω
	g Characteristics (Note 2)			40	40	
t <sub>d(on)</sub>	Turn-On Delay Time			10	19	ns
t <sub>r</sub>	Turn–On Rise Time			5	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time			27	43	ns
t <sub>f</sub>	Turn–Off Fall Time			15	27	ns
Q <sub>g</sub>	Total Gate Charge	$V_{DS} = 15 \text{ V}, \qquad I_D = 12.5 \text{ A}, \\ V_{GS} = 5 \text{ V}$		16	23	nC
Q <sub>gs</sub>	Gate-Source Charge			5		nC
Q <sub>gd</sub>	Gate-Drain Charge			5.8		nC
	Durce Diode Characteristics				04	٨
ls	Maximum Continuous Drain–Source Drain–Source Diode Forward				2.1	A
V <sub>SD</sub>	Voltage	$V_{GS} = 0 V$ , $I_S = 2.1 A$ (Note 2)		0.73	1.2	V
t <sub>rr</sub>	Diode Reverse Recovery Time	$I_F = 12.5 \text{ A},  d_{iF}/d_t = 100 \text{ A}/\mu\text{s}$		28		ns
Q <sub>rr</sub>	Diode Reverse Recovery Charge	1		18		nC

the drain pins.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta CA}$  is determined by the user's board design.





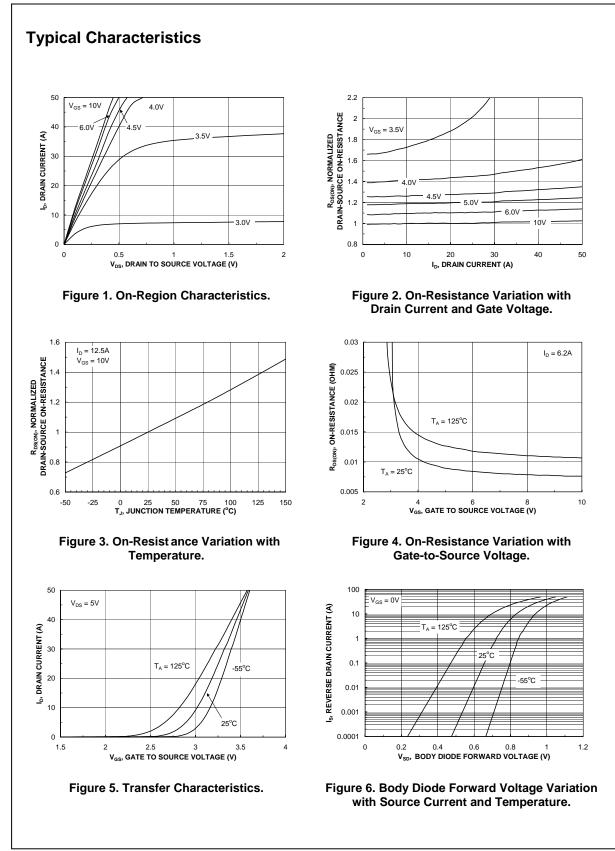
b) 105°C/W when mounted on a .04 in<sup>2</sup> pad of 2 oz copper c) 125°C/W when mounted on a minimum pad.

0000 Scale 1 : 1 on letter size paper

**2.** Pulse Test: Pulse Width <  $300\mu$ s, Duty Cycle < 2.0%

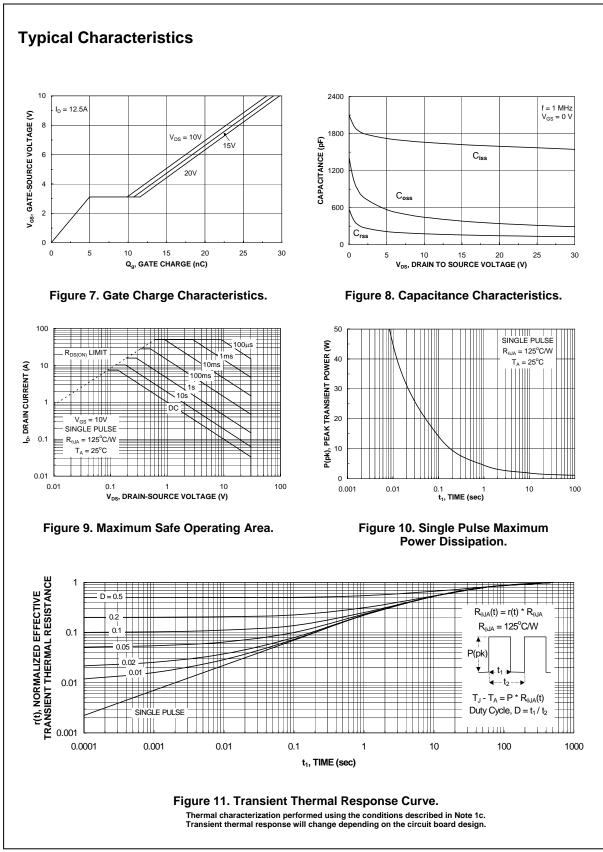
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## FDS6680A



### FDS6680A

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FDS6680A

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